Rochester Electronics

Datasheet

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
  - Class Q Military
  - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
  - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

19-3405; Rev 1; 6/06

EVALUATION KIT AVAILABLE

2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

MAX9705

General Description

The MAX9705 3rd-generation, ultra-low EMI, mono, Class D audio power amplifier provides Class AB performance with Class D efficiency. The MAX9705 delivers 2.3W into a 4Ω load and offers efficiencies above 85%. Active emissions limiting (AEL) circuitry greatly reduces EMI by actively controlling the output FET gate transitions under all possible transient output-voltage conditions. AEL prevents high-frequency emissions resulting from conventional Class D free-wheeling behavior in the presence of an inductive load. Zero dead time (ZDT) technology maintains state-of-the-art efficiency and THD+N performance by allowing the output FETs to switch simultaneously without cross-conduction. A patented spread-spectrum modulation scheme eliminates the need for output filtering found in traditional Class D devices. These design concepts reduce an application's component count and extend battery life.

The MAX9705 offers two modulation schemes: a fixed-frequency (FFM) mode and a spread-spectrum (SSM) mode that further reduces EMI-radiated emissions due to the modulation frequency. The MAX9705 oscillator can be synchronized to an external clock through the SYNC input, allowing the switching frequency to be externally defined. The SYNC input also allows multiple MAX9705s to be cascaded and frequency locked, minimizing interference due to clock intermodulation. The device utilizes a fully differential architecture, a full-bridged output, and comprehensive click-and-pop suppression. The gain of the MAX9705 is set internally (MAX9705A: 6dB, MAX9705B: 12dB, MAX9705C: 15.6dB, MAX9705D: 20dB), further reducing external component count.

The MAX9705 is available in 10-pin TDFN (3mm x 3mm x 0.8mm), 10-pin µMAX®, and 12-bump UCSP™ (1.5mm x 2mm x 0.6mm) packages. The MAX9705 is specified over the extended -40°C to +85°C temperature range.

Applications

- Cellular Phones
- PDAs
- MP3 Players
- Portable Audio

Selector Guide appears at end of data sheet.

Features

- ♦ **Filterless Amplifier Passes FCC-Radiated Emissions Standards with 24in of Cable**
- ♦ **Unique Spread-Spectrum Mode and Active Emissions Limiting (AEL) Achieves Better than 20dB Margin Under FCC Limits**
- ♦ **Zero Dead Time (ZDT) H-Bridge Maintains State-of-the-Art Efficiency and THD+N**
- ♦ **Simple Master-Slave Setup for Stereo Operation**
- ♦ **Up to 90% Efficiency**
- ♦ **2.3W into 4Ω (1% THD+N)**
- ♦ **Low 0.02% THD+N (P_{OUT} = 1W, V_{DD} = 5.0V)**
- ♦ **High PSRR (75dB at 217Hz)**
- ♦ **Integrated Click-and-Pop Suppression**
- ♦ **Low Quiescent Current (5.4mA)**
- ♦ **Low-Power Shutdown Mode (0.3µA)**
- ♦ **Short-Circuit and Thermal-Overload Protection**
- ♦ **Available in Thermally Efficient, Space-Saving Packages**
  - **10-Pin TDFN (3mm x 3mm x 0.8mm)**
  - **10-Pin µMAX**
  - **12-Bump UCSP (1.5mm x 2mm x 0.6mm)**
- ♦ **Pin-for-Pin Compatible with the MAX9700 and MAX9712**

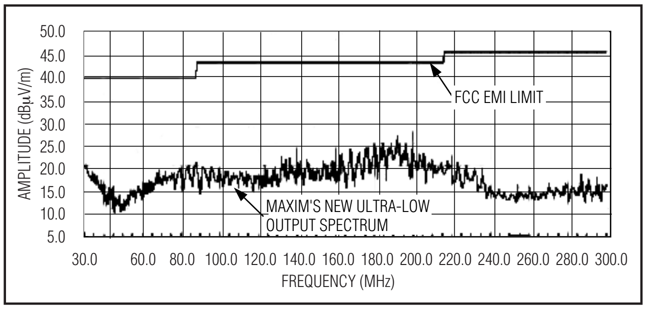
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX9705AETB+T	-40°C to +85°C	10 TDFN-10	ACY
MAX9705AEUB+	-40°C to +85°C	10 µMAX	—
MAX9705AEBC+T	-40°C to +85°C	12 UCSP-12	ACH
MAX9705BETB+T	-40°C to +85°C	10 TDFN-10	ACX
MAX9705BEUB+	-40°C to +85°C	10 µMAX	—
MAX9705BEBC+T	-40°C to +85°C	12 UCSP-12	ACG

Ordering Information continued at end of data sheet.

+Denotes lead-free package.

EMI Spectrum Diagram



2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

ABSOLUTE MAXIMUM RATINGS

V_{DD} to GND 6V
PV_{DD} to PGND 6V
GND to PGND ....-0.3V to +0.3V
PV_{DD} to V_{DD} ....-0.3V to +0.3V
All Other Pins to GND....-0.3V to (V_{DD} + 0.3V)
Continuous Current Into/Out of PV_{DD}/PGND/OUT_....±600mA
Continuous Input Current (all other pins) ....±20mA
Duration of OUT_ Short Circuit to GND or PV_{DD}....Continuous
Duration of Short Circuit Between OUT+ and OUT- ....Continuous
Continuous Power Dissipation (T_A = +70°C)
10-Pin TDFN (derate 24.4mW/°C above +70°C) 1951.2mW
10-Pin µMAX (derate 5.6mW/°C above +70°C)....444.4mW
12-Bump UCSP (derate 6.1mW/°C above +70°C)....484mW
Junction Temperature....+150°C
Operating Temperature Range ....-40°C to +85°C
Storage Temperature Range ....-65°C to +150°C
Lead Temperature (soldering, 10s) ....+300°C
Bump Temperature (soldering)
Reflow ....+235°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(**V_{DD} = PV_{DD} = $\overline{SHDN}$ = 3.3V**, GND = PGND = 0V, SYNC = GND (FFM), R_L = ∞, R_L connected between OUT+ and OUT-, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
GENERAL							
Supply Voltage Range	V_{DD}	Inferred from PSRR test		2.5		5.5	V
Quiescent Current	I_{DD}				5.4	7	mA
Shutdown Current	I_{SHDN}				0.3	10	µA
Turn-On Time	t_{ON}				30		ms
Input Resistance	R_{IN}	T_A = +25°C		12	20		kΩ
Input Bias Voltage	V_{BIAS}	Either input	MAX9705A	0.88	1.0	1.12	V
			MAX9705B	0.73	0.83	0.93	
			MAX9705C	0.61	0.71	0.81	
			MAX9705D	0.48	0.56	0.64	
Voltage Gain	A_V	MAX9705A		1.9	2.0	2.1	V/V
		MAX9705B		3.8	4.0	4.2	
		MAX9705C		5.7	6.0	6.3	
		MAX9705D		9.5	10	10.5	
Output Offset Voltage	V_{OS}	T_A = +25°C			±10	±69	mV
Common-Mode Rejection Ratio	CMRR	f_{IN} = 1kHz, input referred			56		dB
Power-Supply Rejection Ratio (Note 3)	PSRR	V_{DD} = 2.5V to 5.5V, T_A = +25°C		50	75		dB
		200mV$_{P-P}$ ripple	f_{RIPPLE} = 217Hz		75		
			f_{RIPPLE} = 20kHz		60		
Output Power	P_{OUT}	THD+N = 1%, f_{IN} = 1kHz	R_L = 8Ω		600		mW
			R_L = 4Ω MAX9705_ETB+T and MAX9705_EUB+ only		950		
Total Harmonic Distortion Plus Noise	THD+N	f_{IN} = 1kHz, either FFM or SSM	R_L = 8Ω, P_{OUT} = 450mW		0.02		%
			R_L = 4Ω, P_{OUT} = 375mW		0.025		
Click/Pop Level	K_{CP}	Peak voltage, A-weighted (Notes 3, 4)	Into shutdown		-68		dB
			Out of shutdown		-60.5		
Output Slew Rate	SR				176		V/µs

ELECTRICAL CHARACTERISTICS (continued)

(**V_{DD} = PV_{DD} = $\overline{SHDN}$ = 3.3V**, GND = PGND = 0V, SYNC = GND (FFM), R_L = ∞, R_L connected between OUT+ and OUT-, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Rise/Fall Time	t_{RISE}, t_{FALL}	10% to 90%				15		ns
Signal-to-Noise Ratio	SNR	V_{OUT} = $2V_{RMS}$	BW = 22Hz to 22kHz	FFM		91		dB
				SSM		89		
			A-weighted	FFM		93		
				SSM		91		
Oscillator Frequency	f_{OSC}	SYNC = GND			980	1100	1220	kHz
		SYNC = float			1250	1450	1650	
		SYNC = V_{DD} (SSM mode)				1220 ±120		
SYNC Frequency Lock Range					800		2000	kHz
Efficiency	η	P_{OUT} = 800mW, f_{IN} = 1kHz, R_L = 8Ω				89		%
DIGITAL INPUTS ($\overline{SHDN}$, SYNC)								
Input Thresholds		V_{IH}			2			V
		V_{IL}					0.8	
$\overline{SHDN}$ Input Leakage Current						0.1	±10	µA
SYNC Input Current		(Note 5)				-1.25	±10	µA

ELECTRICAL CHARACTERISTICS

(**V_{DD} = PV_{DD} = $\overline{SHDN}$ = 5V**, GND = PGND = 0V, SYNC = GND (FFM), R_L = ∞, R_L connected between OUT+ and OUT-, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Quiescent Current	I_{DD}					7		mA
Shutdown Current	I_{SHDN}					0.55		µA
Power-Supply Rejection Ratio	PSRR	$200mV_{P-P}$ ripple	f = 217Hz			75		dB
			f = 20kHz			60		
Output Power	P_{OUT}	THD+N = 1%, f = 1kHz	R_L = 16Ω			750		mW
			R_L = 8Ω			1400		
			R_L = 4Ω MAX9705_ETB+T and MAX9705_EUB+ only			2300		
Total Harmonic Distortion Plus Noise	THD+N	f = 1kHz, either FFM or SSM	R_L = 8Ω, P_{OUT} = 1.0W			0.02		%
			R_L = 4Ω, P_{OUT} = 1.75W			0.05		
Signal-to-Noise Ratio	SNR	V_{OUT} = $3V_{RMS}$	BW = 22Hz to 22kHz	FFM		94		dB
				SSM		91		
			A-weighted	FFM		97		
				SSM		93		

Note 1: All devices are 100% production tested at +25°C. All temperature limits are guaranteed by design.

Note 2: Testing performed with a resistive load in series with an inductor to simulate an actual speaker load. For R_L = 4Ω, L = 33µH. For R_L = 8Ω, L = 68µH. For R_L = 16Ω, L = 136µH.

Note 3: Inputs AC-coupled to GND.

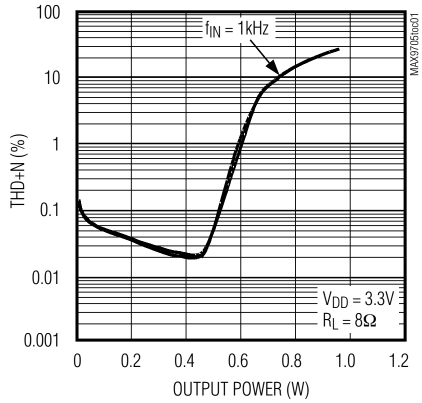
Note 4: Testing performed with 8Ω resistive load in series with 68µH inductive load connected across BTL output. Mode transitions are controlled by $\overline{SHDN}$ pin. K_{CP} level is calculated as 20 x log[(peak voltage under normal operation at rated power level)/(peak voltage during mode transition, no input signal)]. Units are expressed in dB.

Note 5: SYNC has a 1MΩ resistor to V_{REF} = 1.25V.

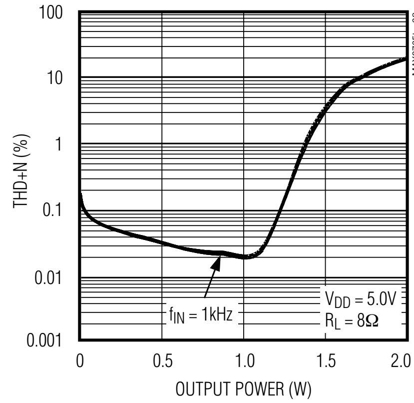
Typical Operating Characteristics

(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted. *Typical Operating Characteristics* for 4Ω load condition apply to the MAX9705_ETB+T and MAX9705_EUB+ only.)

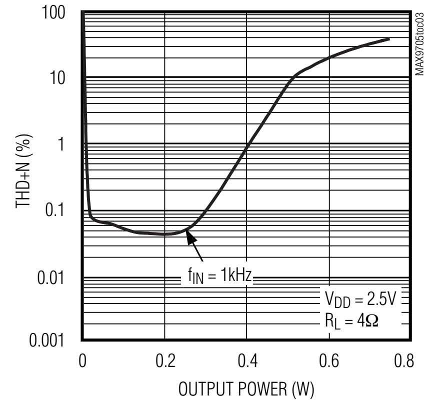
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER



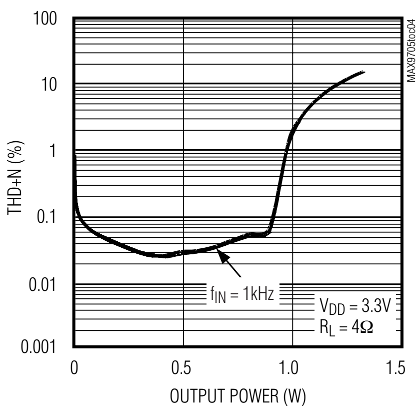
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER



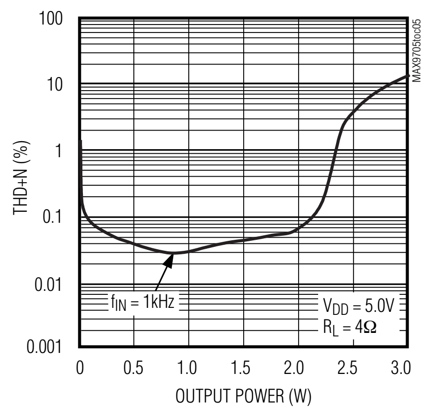
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER



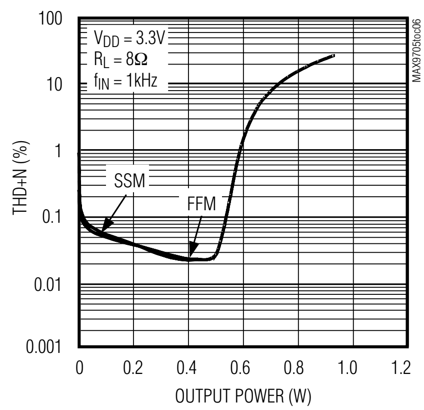
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER



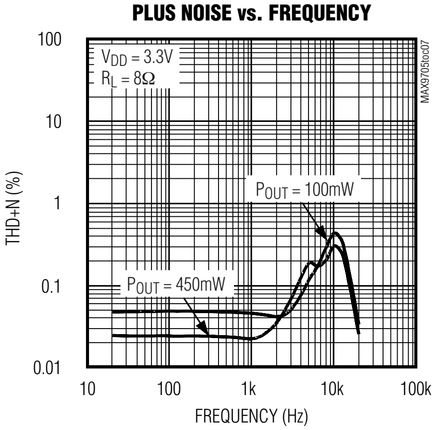
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER



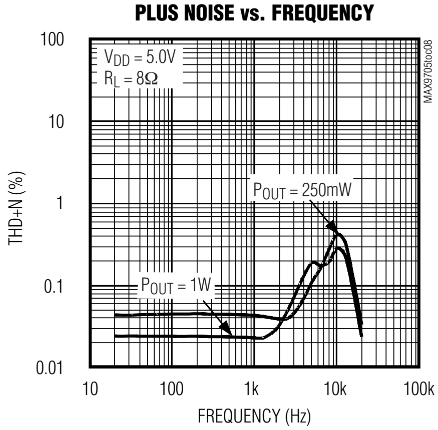
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER



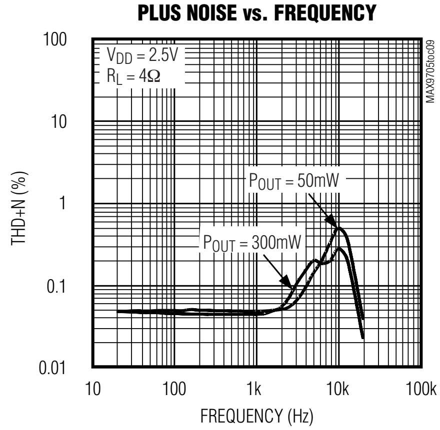
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



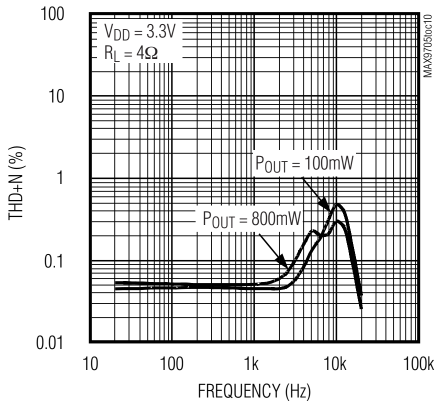
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



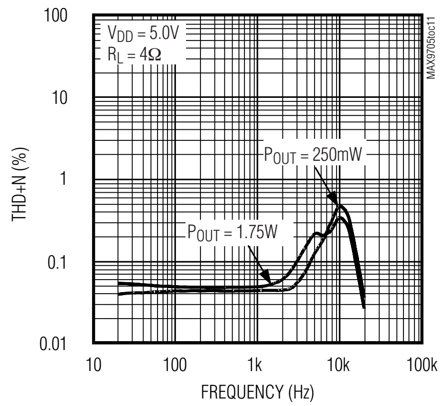
Typical Operating Characteristics (continued)

(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted. *Typical Operating Characteristics* for 4Ω load condition apply to the MAX9705_ETB+T and MAX9705_EUB+ only.)

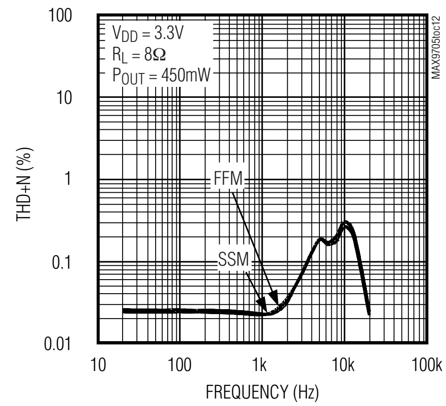
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



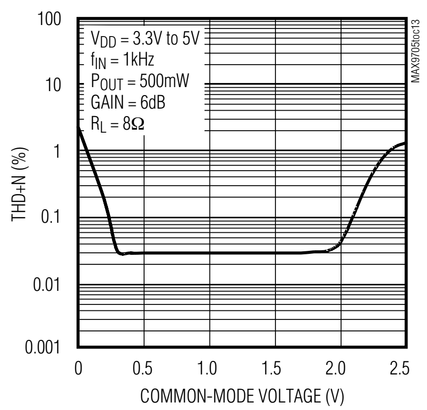
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



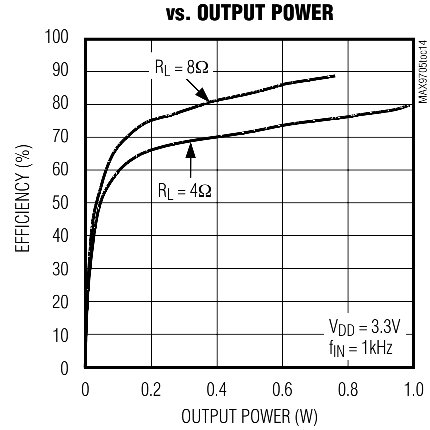
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



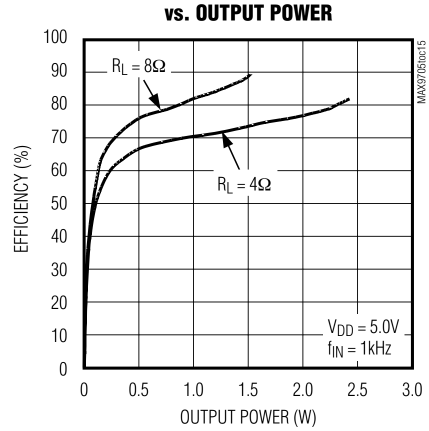
TOTAL HARMONIC DISTORTION PLUS NOISE vs. COMMON-MODE VOLTAGE



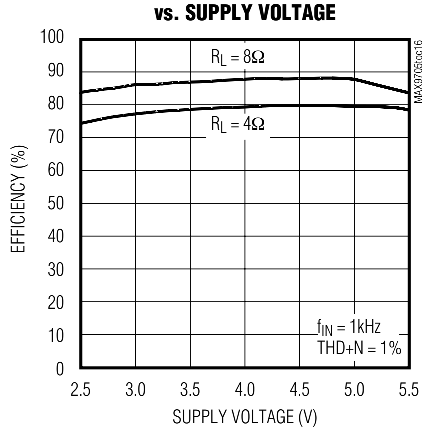
EFFICIENCY vs. OUTPUT POWER



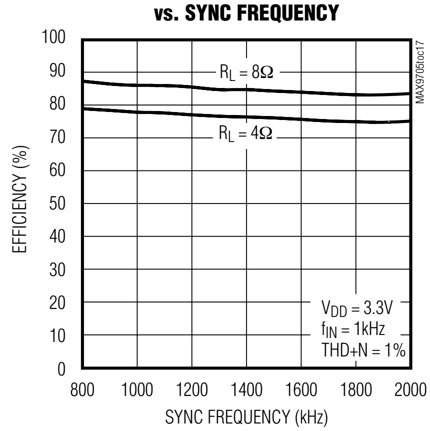
EFFICIENCY vs. OUTPUT POWER



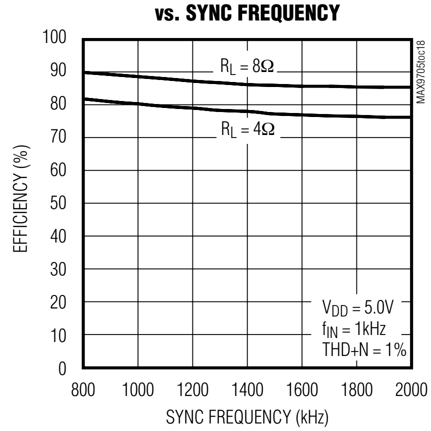
EFFICIENCY vs. SUPPLY VOLTAGE



EFFICIENCY vs. SYNC FREQUENCY



EFFICIENCY vs. SYNC FREQUENCY

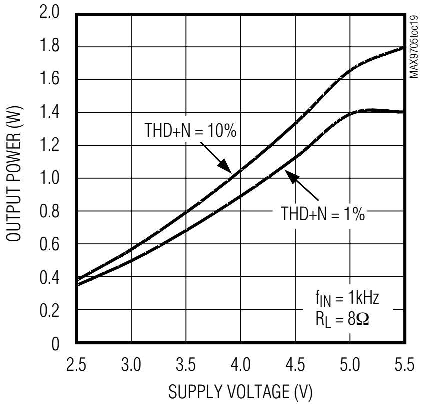


2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

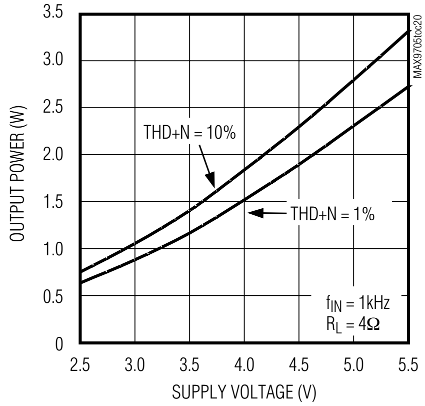
Typical Operating Characteristics (continued)

(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted. *Typical Operating Characteristics* for 4Ω load condition apply to the MAX9705_ETB+T and MAX9705_EUB+ only.)

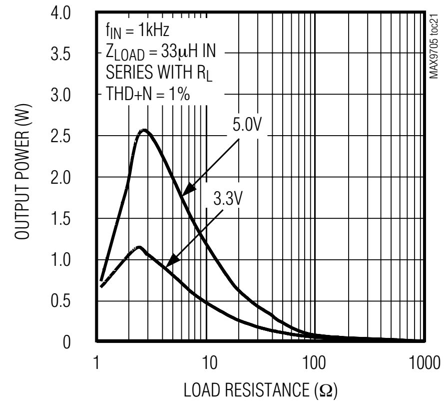
OUTPUT POWER vs. SUPPLY VOLTAGE



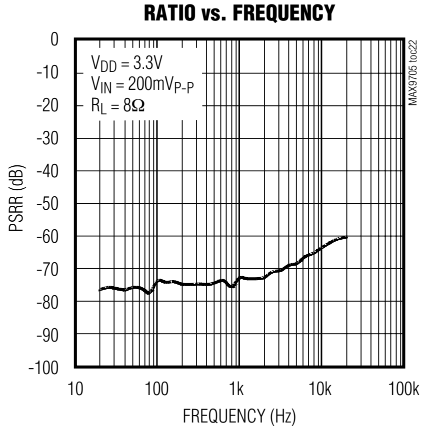
OUTPUT POWER vs. SUPPLY VOLTAGE



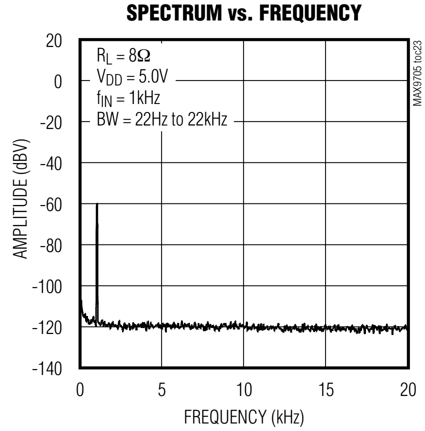
OUTPUT POWER vs. LOAD RESISTANCE



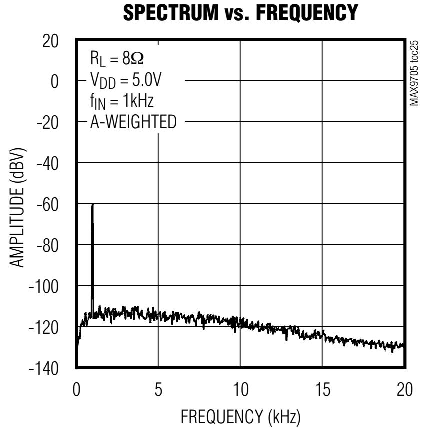
POWER-SUPPLY REJECTION RATIO vs. FREQUENCY



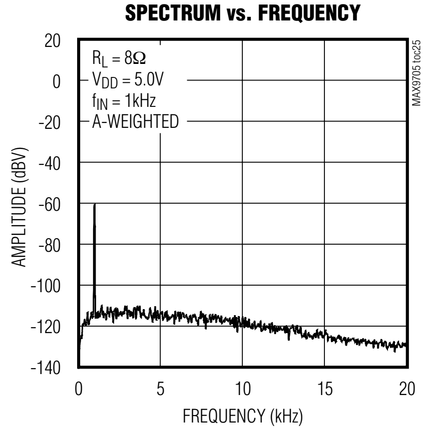
FIXED-FREQUENCY-MODE OUTPUT SPECTRUM vs. FREQUENCY



SPREAD-SPECTRUM-MODE OUTPUT SPECTRUM vs. FREQUENCY



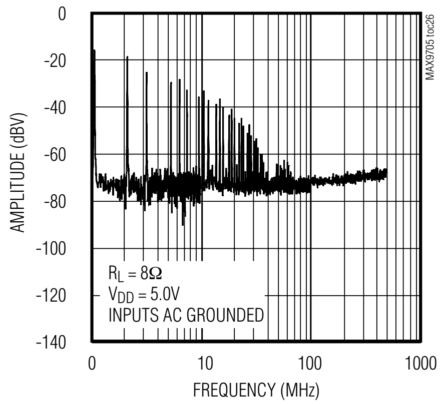
SPREAD-SPECTRUM-MODE OUTPUT SPECTRUM vs. FREQUENCY



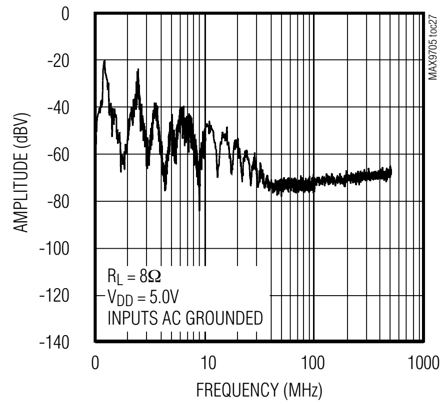
Typical Operating Characteristics (continued)

(V_{DD} = 3.3V, SYNC = V_{DD} (SSM), differential input, T_A = +25°C, unless otherwise noted. *Typical Operating Characteristics* for 4Ω load condition apply to the MAX9705_ETB+T and MAX9705_EUB+ only.)

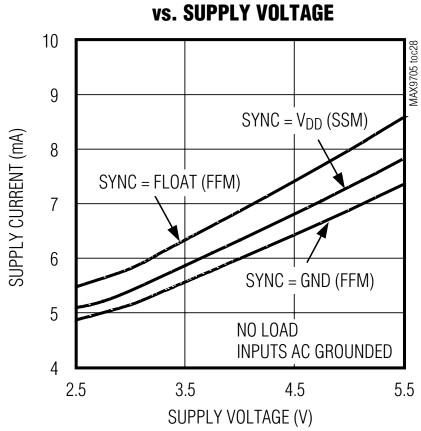
WIDEBAND OUTPUT SPECTRUM FIXED-FREQUENCY MODE



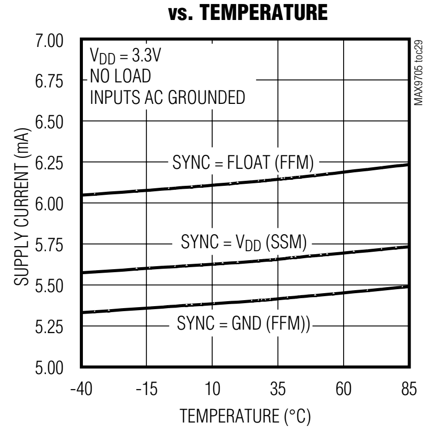
WIDEBAND OUTPUT SPECTRUM SPREAD-SPECTRUM MODE



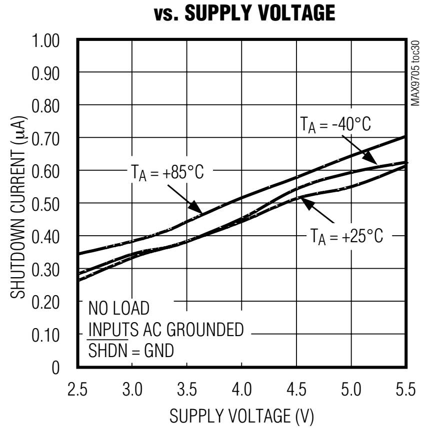
SUPPLY CURRENT vs. SUPPLY VOLTAGE



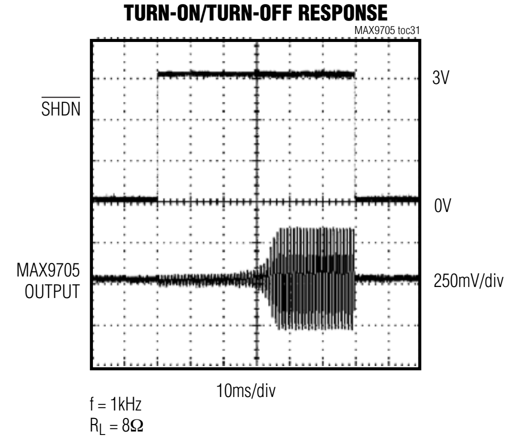
SUPPLY CURRENT vs. TEMPERATURE



SHUTDOWN CURRENT vs. SUPPLY VOLTAGE

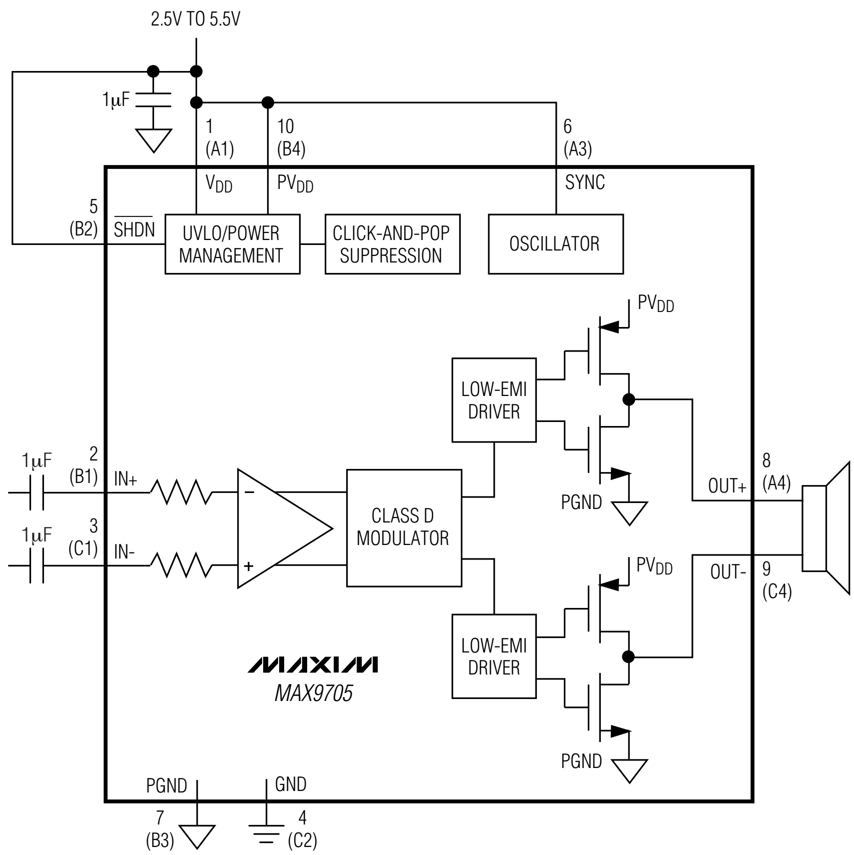


TURN-ON/TURN-OFF RESPONSE



2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

Functional Diagram



( ) UCSP BUMP.
FIGURE SHOWS MAX9705 CONFIGURED FOR SPREAD-SPECTRUM OPERATION.

Pin Description

PIN TDFN/µMAX	BUMP UCSP	NAME	FUNCTION
1	A1	V_{DD}	Analog Power Supply
2	B1	IN+	Noninverting Audio Input
3	C1	IN-	Inverting Audio Input
4	C2	GND	Analog Ground
5	B2	$\overline{SHDN}$	Active-Low Shutdown Input. Connect to V_{DD} for normal operation.
6	A3	SYNC	Frequency Select and External Clock Input. **SYNC = GND:** Fixed-frequency mode with f_S = 1100kHz. **SYNC = Float:** Fixed-frequency mode with f_S = 1450kHz. **SYNC = V_{DD}:** Spread-spectrum mode with f_S = 1220kHz ±120kHz. **SYNC = Clocked:** Fixed-frequency mode with f_S = external clock frequency.
7	B3	PGND	Power Ground
8	A4	OUT+	Amplifier-Output Positive Phase
9	C4	OUT-	Amplifier-Output Negative Phase
10	B4	PV_{DD}	H-Bridge Power Supply

Detailed Description

The MAX9705 ultra-low-EMI, filterless, Class D audio power amplifier features several improvements to switch-mode amplifier technology. The MAX9705 features output driver active emissions limiting circuitry to reduce EMI. Zero dead time technology maintains state-of-the-art efficiency and THD+N performance by allowing the output FETs to switch simultaneously without cross-conduction. A unique filterless modulation scheme, synchronizable switching frequency, and spread-spectrum mode create a compact, flexible, low-noise, efficient audio power amplifier while occupying minimal board space. The differential input architecture reduces common-mode noise pickup with or without the use of input-coupling capacitors. The MAX9705 can also be configured as a single-ended input amplifier without performance degradation.

Thermal-overload and short-circuit protection prevent the MAX9705 from being damaged during a fault condition. The amplifier is disabled if the die temperature reaches +125°C. The die must cool by 10°C before normal operation can continue. The output of the MAX9705 shuts down if the output current reaches approximately 2A. Each output FET has its own short-circuit protection. This protection scheme allows the amplifier to survive shorts to either supply rail. After a thermal overload or short circuit, the device remains disabled for a minimum of 50µs before attempting to return to normal operation. The amplifier will shut down immediately and wait another 50µs before turning on if the fault condition is still present. This operation will cause the output to pulse during a persistent fault.

Comparators monitor the MAX9705 inputs and compare the complementary input voltages to the sawtooth waveform. The comparators trip when the input magnitude of the sawtooth exceeds their corresponding input voltage. Both comparators reset at a fixed time after the rising edge of the second comparator trip point, generating a minimum-width pulse $t_{ON(MIN)}$ at the output of the second comparator (Figure 1). As the input voltage increases or decreases, the duration of the pulse at one output increases (the first comparator to trip), while the other output pulse duration remains at $t_{ON(MIN)}$. This causes the net voltage across the speaker (V_{OUT+} - V_{OUT-}) to change.

Operating Modes

Fixed-Frequency Modulation (FFM) Mode

The MAX9705 features two FFM modes. The FFM modes are selected by setting SYNC = GND for a 1.1MHz switching frequency, and SYNC = FLOAT for a 1.45MHz switching frequency. In FFM mode, the frequency spectrum of the Class D output consists of the fundamental switching frequency and its associated harmonics (see the Wideband Output Spectrum Fixed-Frequency Mode graph in the *Typical Operating Characteristics*). The MAX9705 allows the switching frequency to be changed by +32%, should the frequency of one or more of the harmonics fall in a sensitive band. This can be done at any time and does not affect audio reproduction.

Spread-Spectrum Modulation (SSM) Mode

The MAX9705 features a unique, patented spread-spectrum mode that flattens the wideband spectral components,

2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

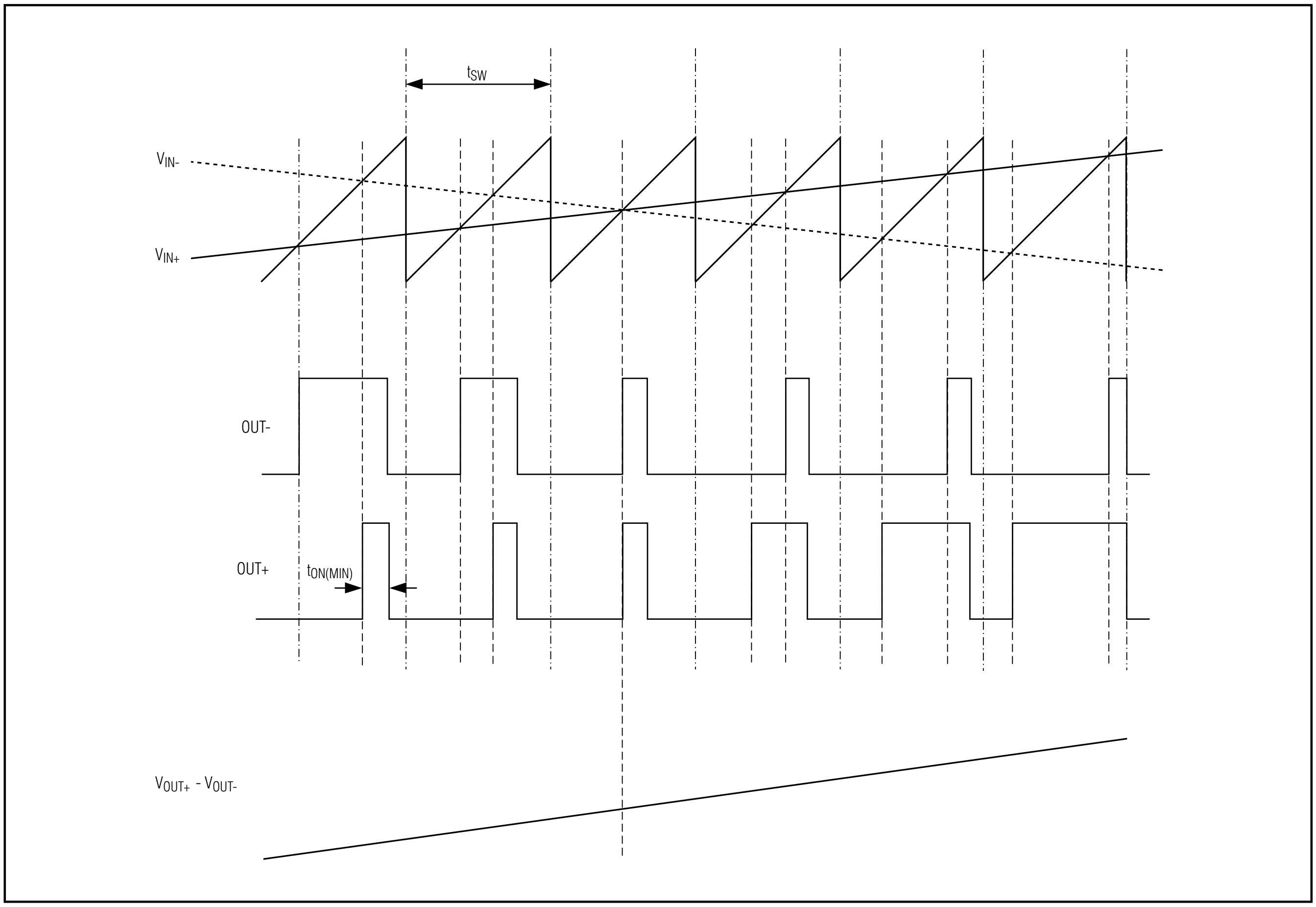


Figure 1. MAX9705 Outputs with an Input Signal Applied

Table 1. Operating Modes

SYNC INPUT	MODE
GND	FFM with f_S = 1100kHz
FLOAT	FFM with f_S = 1450kHz
V_{DD}	SSM with f_S = 1220kHz ±120kHz
Clocked	FFM with f_S = external clock frequency

improving EMI emissions by 5dB. Proprietary techniques ensure that the cycle-to-cycle variation of the switching period does not degrade audio reproduction or efficiency (see the *Typical Operating Characteristics*). Select SSM mode by setting SYNC = V_{DD}. In SSM mode, the switching frequency varies randomly by ±120kHz around the center frequency (1.22MHz). The modulation scheme remains the same, but the period of the sawtooth waveform changes from cycle to cycle (Figure 2). Instead of a large amount of spectral energy present at multiples of the switching frequency, the energy is now spread over a bandwidth that increases with frequency. Above a few megahertz, the wideband spectrum looks like white noise for EMI purposes (see the *EMI Spectrum Diagram*).

External Clock Mode

The SYNC input allows the MAX9705 to be synchronized to a system clock moving the spectral components of the switching harmonics to insensitive frequency bands. Applying an external TTL clock of 800kHz to 2MHz to SYNC synchronizes the switching frequency of the MAX9705. The period of the SYNC clock can be randomized, enabling the MAX9705 to be synchronized to another MAX9705 operating in SSM mode.

Filterless Modulation/Common-Mode Idle

The MAX9705 uses Maxim's unique, patented modulation scheme that eliminates the LC filter required by traditional Class D amplifiers, improving efficiency, reducing component count, and conserving board

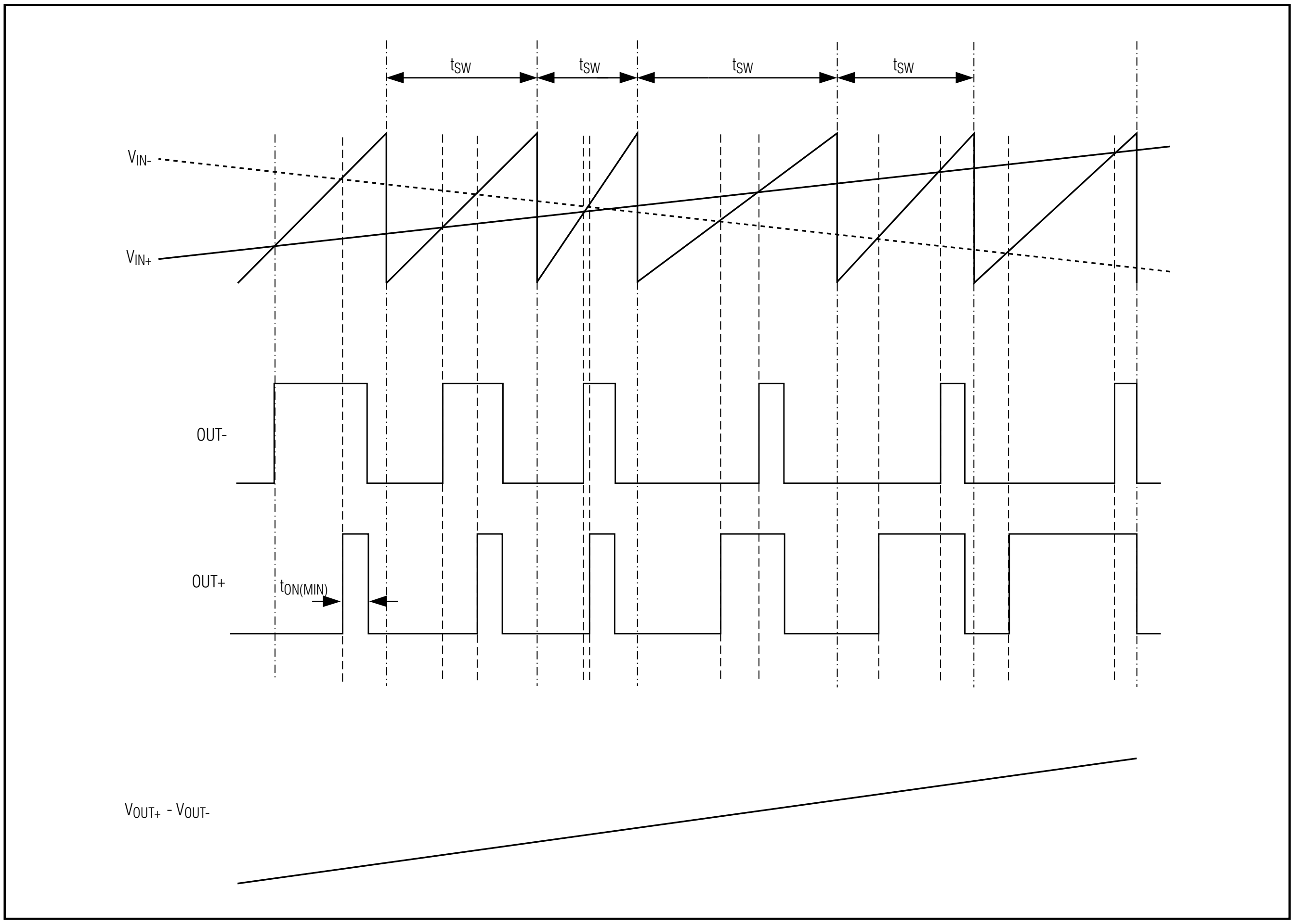


Figure 2. MAX9705 Output with an Input Signal Applied (SSM Mode)

space and system cost. Conventional Class D amplifiers output a 50% duty cycle square wave when no signal is present. With no filter, the square wave appears across the load as a DC voltage, resulting in a finite load current, increasing power consumption. When no signal is present at the input of the MAX9705, the outputs switch as shown in Figure 3. Because the MAX9705 drives the speaker differentially, the two outputs cancel each other, resulting in no net idle-mode voltage across the speaker, minimizing power consumption.

Efficiency

Efficiency of a Class D amplifier is attributed to the region of operation of the output stage transistors. In a Class D amplifier, the output transistors act as current-steering switches and consume negligible additional power. Any power loss associated with the Class D output stage is mostly due to the I^2R loss of the MOSFET on-resistance and supply current.

The theoretical best efficiency of a linear amplifier is 78%; however, that efficiency is only exhibited at peak output powers. Under normal operating levels (typical music reproduction levels), efficiency falls below 30%, whereas the MAX9705 still exhibits >70% efficiencies under the same conditions (Figure 4).

Shutdown

The MAX9705 has a shutdown mode that reduces power consumption and extends battery life. Driving $\overline{SHDN}$ low places the MAX9705 in a low-power (0.3µA) shutdown mode. Connect $\overline{SHDN}$ to V_{DD} for normal operation.

2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

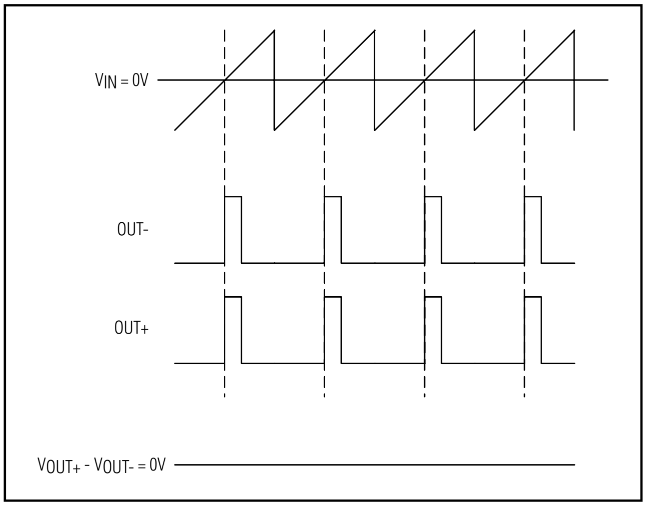


Figure 3. MAX9705 Outputs with No Input Signal

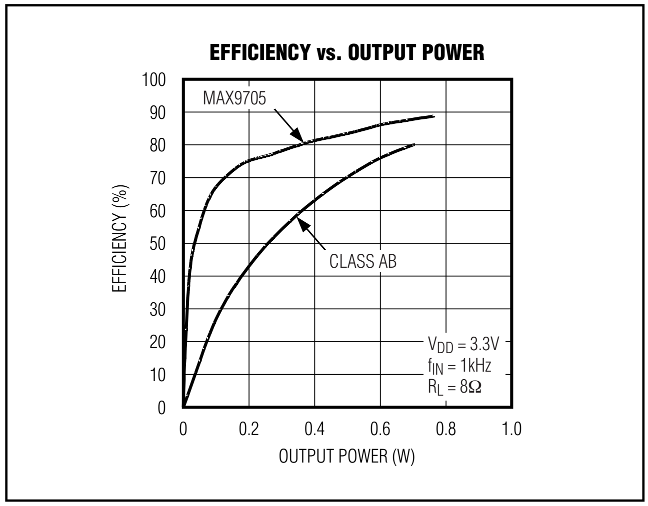


Figure 4. MAX9705 Efficiency vs. Class AB Efficiency

Click-and-Pop Suppression

The MAX9705 features comprehensive click-and-pop suppression that eliminates audible transients on startup and shutdown. While in shutdown, the H-bridge is in a high-impedance state. During startup or power-up, the input amplifiers are muted and an internal loop sets the modulator bias voltages to the correct levels, preventing clicks and pops when the H-bridge is subsequently enabled. For 30ms following startup, a soft-start function gradually unmutes the input amplifiers.

Applications Information

Filterless Operation

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's output. The filters add cost, increase the solution size of the amplifier, and can decrease efficiency and THD+N performance. The traditional PWM scheme uses large differential output swings (2 x V_{DD} peak-to-peak) and causes large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering the efficiency.

The MAX9705 does not require an output filter. The device relies on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, more efficient solution.

Because the frequency of the MAX9705 output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency is very small. Although this movement is small, a speaker not designed to handle the additional power can be damaged. For optimum results, use a speaker with a series inductance >10µH. Typical 8Ω speakers exhibit series inductances in the 20µH to 100µH range.

Power-Conversion Efficiency

Unlike a class AB amplifier, the output offset voltage of a Class D amplifier does not noticeably increase quiescent-current draw when a load is applied. This is due to the power conversion of the Class D amplifier. For example, an 8mV DC offset across an 8Ω load results in 1mA extra current consumption in a Class AB device. In the Class D case, an 8mV offset into 8Ω equates to an additional power drain of 8µW. Due to the high efficiency of the Class D amplifier, this represents an additional quiescent-current draw of 8µW/(V_{DD}/100η), which is on the order of a few microamps.

Input Amplifier

Differential Input

The MAX9705 features a differential input structure, making it compatible with many CODECs, and offering improved noise immunity over a single-ended input amplifier. In devices such as cellular phones, high-frequency signals from the RF transmitter can be picked up by the amplifier's input traces. The signals appear at the amplifier's inputs as common-mode noise. A differential input amplifier amplifies the difference of the two inputs; any signal common to both inputs is canceled.

Single-Ended Input

The MAX9705 can be configured as a single-ended input amplifier by capacitively coupling either input to GND and driving the other input (Figure 5).

Note that the single-ended voltage range of the MAX9705A is $3V_{P-P}$. This limits the achievable output power for this device. Use higher gain versions (MAX9705B, MAX9705C, MAX9705D) if higher output power is desired in a single-ended application.

DC-Coupled Input

The input amplifier can accept DC-coupled inputs that are biased within the amplifier's common-mode range (see the *Typical Operating Characteristics*). DC coupling eliminates the input-coupling capacitors, reducing component count to potentially one external component (see the *System Diagram*). However, the low-frequency rejection of the capacitors is lost, allowing low-frequency signals to feed through to the load.

Component Selection

Input Filter

An input capacitor, C_{IN}, in conjunction with the input resistance of the MAX9705 forms a highpass filter that removes the DC bias from an incoming signal. The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi \ R_{IN} \ C_{IN}}$$

Choose C_{IN} so f_{-3dB} is well below the lowest frequency of interest. Setting f_{-3dB} too high affects the low-frequency response of the amplifier. Use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies. If a ceramic capacitor is selected due to size constraints, use the largest package possible to minimize voltage coefficient effects. In addition, use X7R dielectrics as opposed to Y5V or Z5U.

Other considerations when designing the input filter include the constraints of the overall system and the actual frequency band of interest. Although high-fidelity audio calls for a flat gain response between 20Hz and 20kHz, portable voice-reproduction devices such as cellular phones and two-way radios need only concentrate on the frequency range of the spoken human voice (typically 300Hz to 3.5kHz). In addition, speakers used in portable devices typically have a poor response below 150Hz. Taking these two factors into consideration, the input filter may not need to be designed for a 20Hz to 20kHz response, saving both board space and cost due to the use of smaller capacitors.

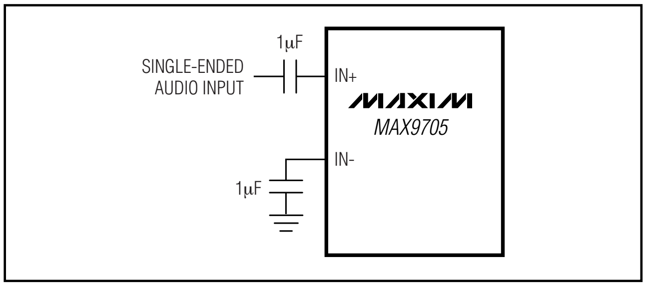


Figure 5. Single-Ended Input

Output Filter

The MAX9705 does not require an output filter. The device passes FCC emissions standards with 24in of unshielded twisted-pair speaker cables. However, an output filter can be used if a design is failing radiated emissions due to board layout or excessive cable length, or the circuit is near EMI-sensitive devices.

Supply Bypassing/Layout

Proper power-supply bypassing ensures low-distortion operation. For optimum performance, bypass V_{DD} to GND and PV_{DD} to PGND with separate 1µF capacitors as close to each pin as possible. A low-impedance, high-current power-supply connection to PV_{DD} is assumed. Additional bulk capacitance should be added as required depending on the application and power-supply characteristics. GND and PGND should be star connected to system ground. Refer to the MAX9705 evaluation kit for layout guidance.

Stereo Configuration

Two MAX9705s can be configured as a stereo amplifier (Figure 6). Device U1 is the master amplifier; its unfiltered output drives the SYNC input of the slave device (U2), synchronizing the switching frequencies of the two devices. Synchronizing two MAX9705s ensures that no beat frequencies occur within the audio spectrum. This configuration works when the master device is in either FFM or SSM mode. There is excellent THD+N performance and minimal crosstalk between devices due to the SYNC connection (Figures 7 and 8). U2 locks onto only the frequency present at SYNC, not the pulse width. The internal feedback loop of device U2 ensures that the audio component of U1's output is rejected.

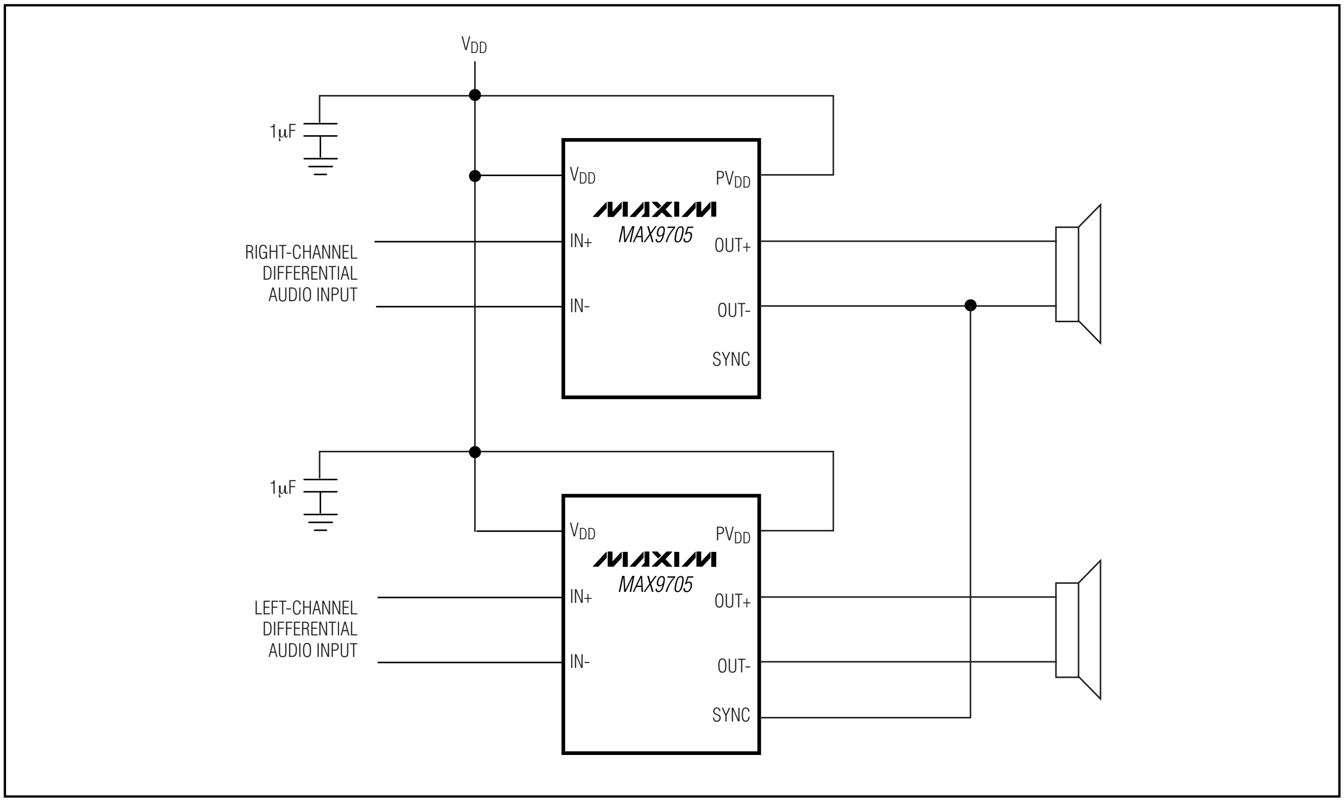


Figure 6. Master-Slave Stereo Configuration

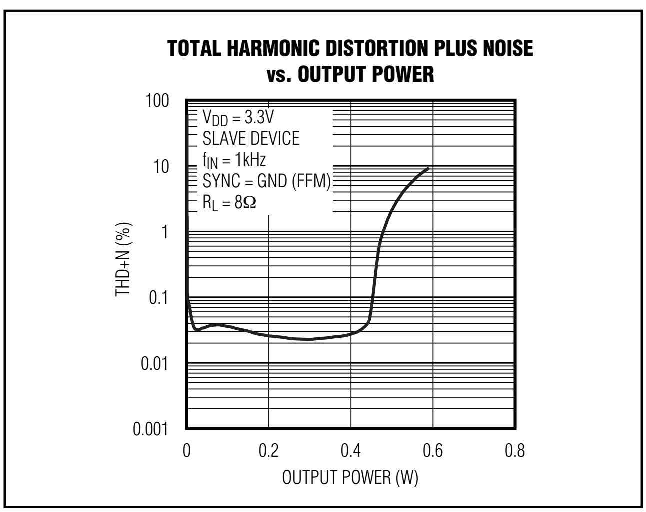


Figure 7. Master-Slave THD+N

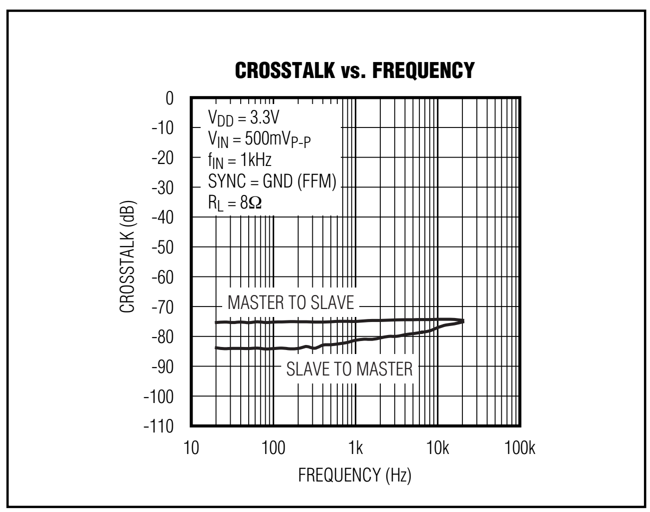


Figure 8. Master-Slave Crosstalk

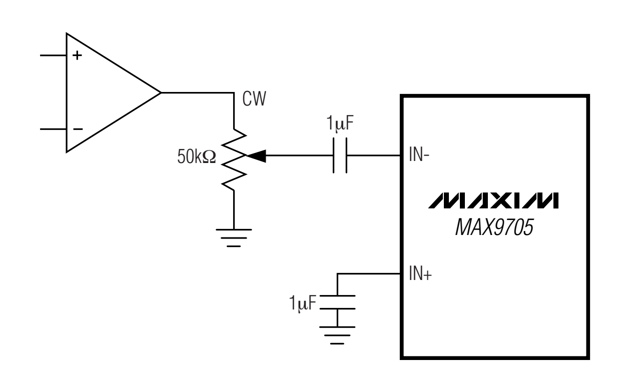


Figure 9a. Single-Ended Drive of MAX9705 Plus Volume

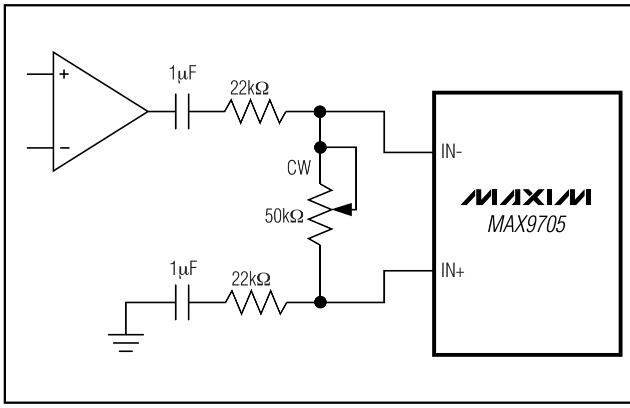
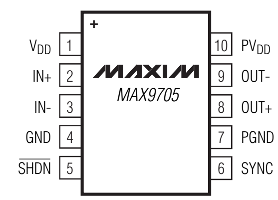


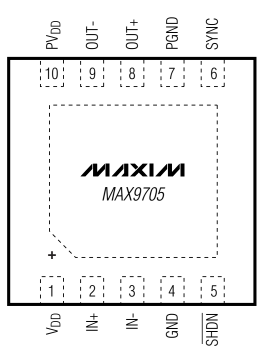
Figure 9b. Improved Single-Ended Drive of MAX9705 Plus Volume

Pin Configurations

TOP VIEW

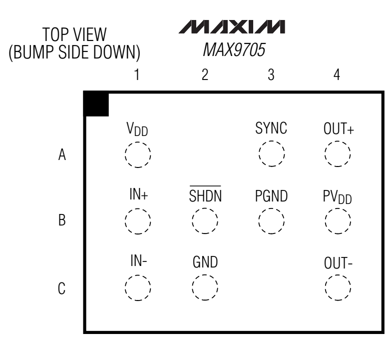


µMAX



TDFN

TOP VIEW
(BUMP SIDE DOWN)



UCSP

Selector Guide

PART	PIN-PACKAGE	GAIN (dB)
MAX9705AETB+T	10 TDFN-10	6
MAX9705AEUB+	10 µMAX	6
MAX9705AEBC+T	12 UCSP-12	6
MAX9705BETB+T	10 TDFN-10	12
MAX9705BEUB+	10 µMAX	12
MAX9705BEBC+T	12 UCSP-12	12
MAX9705CETB+T	10 TDFN-10	15.6
MAX9705CEUB+	10 µMAX	15.6
MAX9705CEBC+T	12 UCSP-12	15.6
MAX9705DETB+T	10 TDFN-10	20
MAX9705DEUB+	10 µMAX	20
MAX9705DEBC+T	12 UCSP-12	20

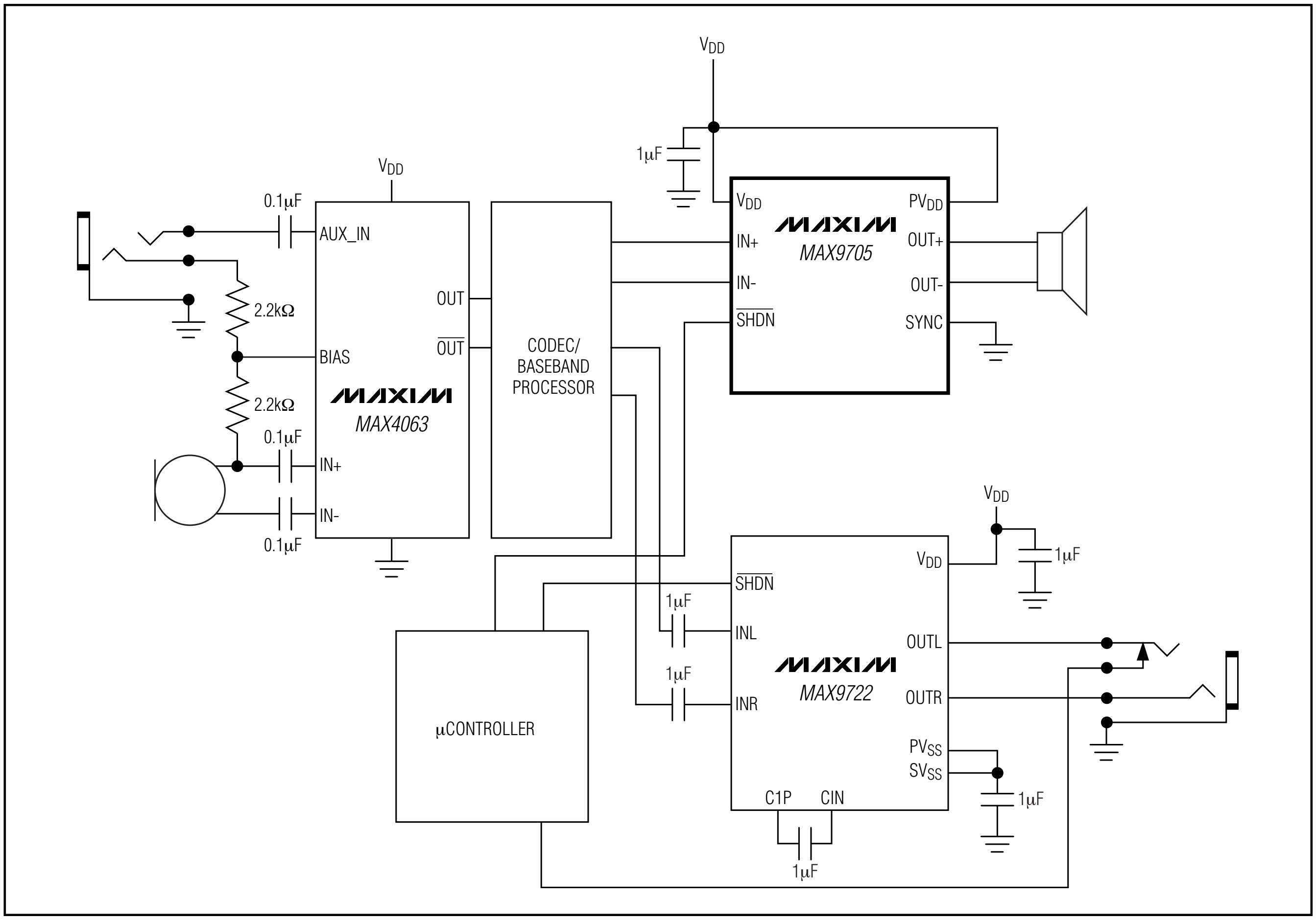
Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX9705CETB+T	-40°C to +85°C	10 TDFN-10	ACZ
MAX9705CEUB+	-40°C to +85°C	10 µMAX	—
MAX9705CEBC+T	-40°C to +85°C	12 UCSP-12	ACI
MAX9705DETB+T	-40°C to +85°C	10 TDFN-10	ADA
MAX9705DEUB+	-40°C to +85°C	10 µMAX	—
MAX9705DEBC+T	-40°C to +85°C	12 UCSP-12	ACJ

+Denotes lead-free package.

2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

System Diagram



Chip Information

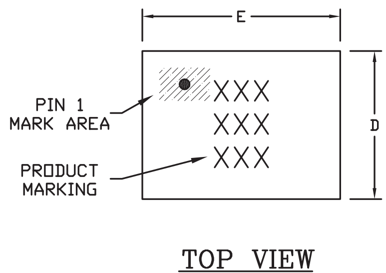
TRANSISTOR COUNT: 3595

PROCESS: BiCMOS

Package Information

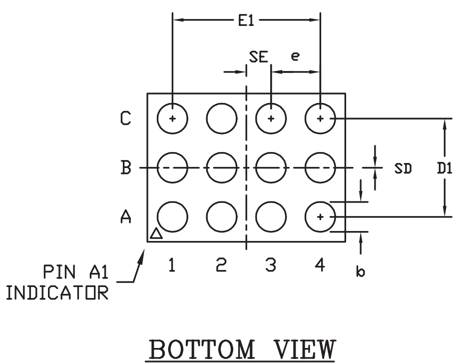
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

12L, UCSP 4x3.EPS

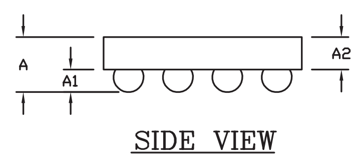


COMMON DIMENSIONS	
A	0.62+0.05−0.08
A1	0.29±0.02
A2	0.33 REF.
b	∅0.35±0.03
D1	1.00 BASIC
E1	1.50 BASIC
e	0.50 BASIC
SD	0.00 BASIC
SE	0.25 BASIC

PKG. CODE	VARIABLE DIMENSIONS D	VARIABLE DIMENSIONS E	DEPOPULATED SOLDER BALLS
B12-1	1.54±0.05	2.02±0.05	NONE
B12-2	1.54±0.05	2.02±0.05	B3
B12-3	1.54±0.05	2.12±0.05	NONE
B12-4	1.54±0.05	2.02±0.05	B2, B3
B12-5	1.64±0.05	2.12±0.05	B2
B12-6	1.64±0.05	2.12±0.05	B3
B12-7	1.54±0.05	2.02±0.05	B1, B3
B12-8	1.54±0.05	2.02±0.05	B2
B12-9	1.54±0.05	2.12±0.05	B2, B3
B12-10	1.54±0.05	2.02±0.05	B1, B2, B3, B4
B12-11	1.54±0.05	2.02±0.05	A2, C3



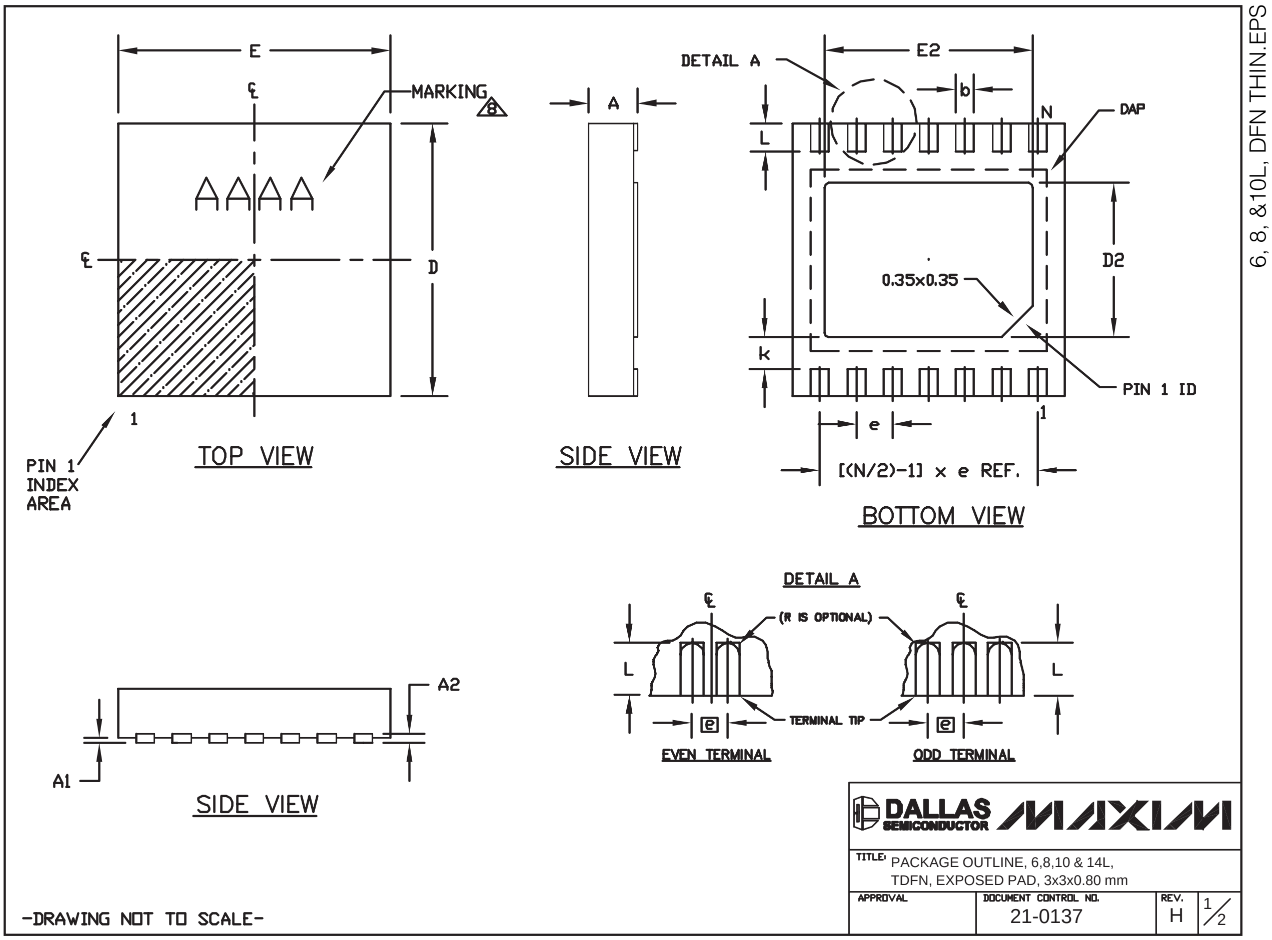
NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. PRODUCT MARKING: NUMBER OF CHARACTERS AND LINES VARY PER PRODUCT.



DALLAS SEMICONDUCTOR MAXIM
PROPRIETARY INFORMATION
TITLE: PACKAGE OUTLINE, 4x3 UCSP
APPROVAL | DOCUMENT CONTROL NO. 21-0104 | REV. F | 1/1

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN.	
A2	0.20 REF.	

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
T633-1	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T833-1	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF

NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
6. "N" IS THE TOTAL NUMBER OF LEADS.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
8. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

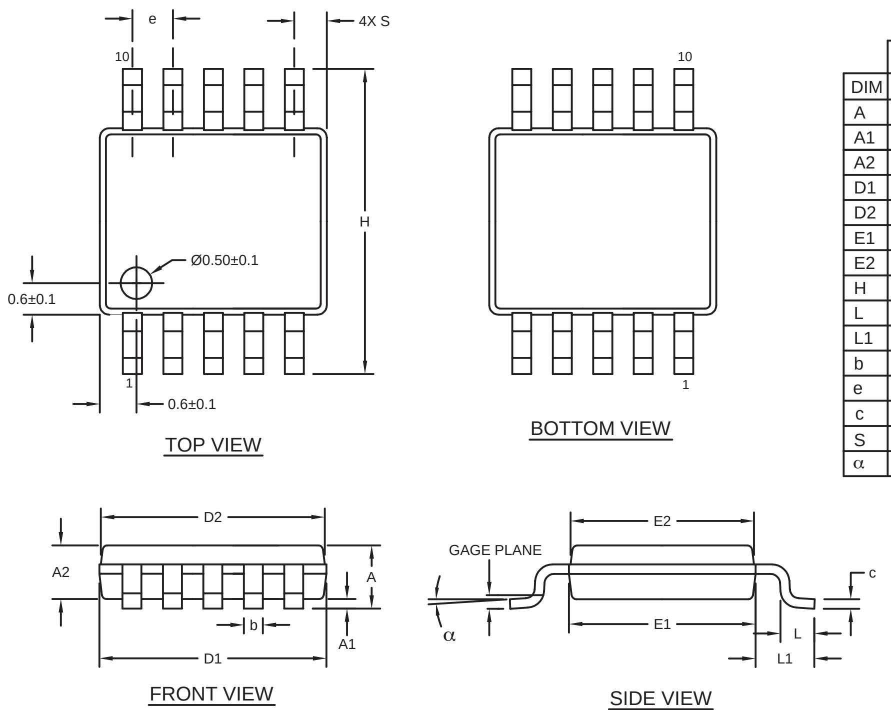
APPROVAL | DOCUMENT CONTROL NO. 21-0137 | REV. H | 2/2

-DRAWING NOT TO SCALE-

2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	-	0.043	-	1.10
A1	0.002	0.006	0.05	0.15
A2	0.030	0.037	0.75	0.95
D1	0.116	0.120	2.95	3.05
D2	0.114	0.118	2.89	3.00
E1	0.116	0.120	2.95	3.05
E2	0.114	0.118	2.89	3.00
H	0.187	0.199	4.75	5.05
L	0.0157	0.0275	0.40	0.70
L1	0.037 REF		0.940 REF	
b	0.007	0.0106	0.177	0.270
e	0.0197 BSC		0.500 BSC	
c	0.0035	0.0078	0.090	0.200
S	0.0196 REF		0.498 REF	
α	0°	6°	0°	6°

10LUMAX.EPS

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. CONTROLLING DIMENSION: MILLIMETERS.
4. MEETS JEDEC MO-187C-BA.

DALLAS SEMICONDUCTOR MAXIM

PROPRIETARY INFORMATION

TITLE:

PACKAGE OUTLINE, 10L uMAX/uSOP

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0061	I	1/1

Revision History

Pages changed at Rev 1: 1, 2–7, 9, 11, 13, 16, 20

MAX9705

2.3W, Ultra-Low-EMI, Filterless, Class D Audio Amplifier

Ordering Information

Notes:

1. Other options and links for purchasing parts are listed at: http://www.maxim-ic.com/sales.
2. Didn't Find What You Need? Ask our applications engineers. Expert assistance in finding parts, usually within one business day.
3. Part number suffixes: T or T&R = tape and reel; + = RoHS/lead-free; # = RoHS/lead-exempt. More: SeeFull Data Sheet or Part Naming Conventions.
4. * Some packages have variations, listed on the drawing. "PkgCode/Variation" tells which variation the product uses.

Devices: 1-16 of 16

MAX9705	Free Sample	Buy	Package: TYPE PINS FOOTPRINT DRAWING CODE/VAR *	Temp	RoHS/Lead-Free? Materials Analysis
MAX9705DETB+			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705BETB+			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705AETB+			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705CETB+			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705BETB+T			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705DETB+T			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705AETB+T			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705CETB+T			THIN QFN (Dual);10 pin;10 mm Dwg: 21-0137I (PDF) Use pkgcode/variation: T1033+1*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705DEBC+			UCSP;10 pin;3 mm Dwg: 21-0104F (PDF) Use pkgcode/variation: B12+11*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705CEBC+			UCSP;10 pin;3 mm Dwg: 21-0104F (PDF) Use pkgcode/variation: B12+11*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705BEBC+			UCSP;10 pin;3 mm Dwg: 21-0104F (PDF) Use pkgcode/variation: B12+11*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
MAX9705AEBC+			UCSP;10 pin;3 mm Dwg: 21-0104F (PDF) Use pkgcode/variation: B12+11*	-40C to +85C	RoHS/Lead-Free: Lead Free Materials Analysis
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